



FILE COPY #3

SON-1745

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of)
SEIICHI FUKUDA) ATT: APPLICATION PROCESSING
Application No. 09/512,336) DIVISION'S CUSTOMER
Filed: February 24, 2000) CORRECTION BRANCH
For: DRY ETCHING METHOD AND)
METHOD OF MANUFACTURING)
SEMICONDUCTOR APPARATUS)

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

It is respectfully requested that a corrected filing receipt be issued in connection with the above-identified application. The corrected notice is necessitated to correct the title as claimed. Specifically, the title should read; --DRY ETCHING METHOD AND METHOD OF MANUFACTURING SEMICONDUCTOR APPARATUS--, rather than "DRY ETCHING METHOD AND METHOD OF MANUFATURING APPARATUS".

The original filing receipt is attached. It is believed that a corrected filing receipt is necessitated because of an error by the Office. However, should any fee be involved, please charge Deposit Account No. 18-0013.

Respectfully submitted,

Ronald P. Kananen
Reg. No. 24,104

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FILING RECEIPT

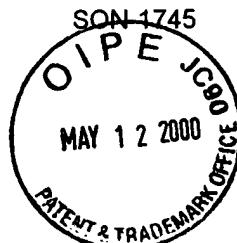
OC00000005044119


**UNITED STATES DEPARTMENT OF COMMERCE
Patent and Trademark Office**

 Address: ASSISTANT SECRETARY AND
COMMISSIONER OF PATENT AND TRADEMARKS
Washington, D.C. 20231

APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/512,336	02/24/2000	2825	690	SON 1745 JC80	6	8	2

Ronald P Kananen
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 1233 20th Street N W Suite 501
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Date Mailed: 04/12/2000

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Seiichi Fukuda, Kanagawa, JAPAN;

Continuing Data as Claimed by Applicant**Foreign Applications**

JAPAN P11-048638 02/25/1999

If Required, Foreign Filing License Granted 04/11/2000

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Title

Dry etching method and method of manufacturing semiconductor apparatus

MANUFACTURING

Preliminary Class

438

Data entry by : LADRINGAN, JUDITH

Team : OIPE

Date: 04/12/2000



**LICENSE FOR FOREIGN FILING UNDER
Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15**



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PLEASE NOTE the following information about the Filing Receipt:

- The articles such as "a," "an" and "the" are not included as the first words in the title of an application. They are considered to be unnecessary to the understanding of the title.
- The words "new," "improved," "improvements in" or "relating to" are not included as first words in the title of an application because a patent application, by nature, is a new idea or improvement.
- The title may be truncated if it consists of more than 600 characters (letters and spaces combined).
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- If your application was submitted under 37 CFR 1.10, your filing date should be the "date in" found on the Express Mail label. If there is a discrepancy, you should submit a request for a corrected Filing Receipt along with a copy of the Express Mail label showing the "date in."

Any corrections that may need to be done to your Filing Receipt should be directed to:

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